

Features

- ESD/EFT/Surge Protection for 1 Line with Bi-directional.
- Provide ESD protection for each line to
 IEC 61000-4-2 (ESD) ±25kV (air / contact)
 IEC 61000-4-4 (EFT) 80A (5/50ns)
 IEC 61000-4-5 (Lightning) 16A (8/20µs)
- Suitable for, 5V and below, operating voltage applications
- 0201 small CSP package saves board space
- Protect one I/O line or one power line
- Fast turn-on and Low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- Green part

Applications

- Mobile Phones
- Hand Held Portable Applications
- Computer Interfaces Protection
- Microprocessors Protection
- Serial and Parallel Port Protection
- Control Signal Lines Protection
- Power Lines on PCB Protection
- Latchup Protection

Description

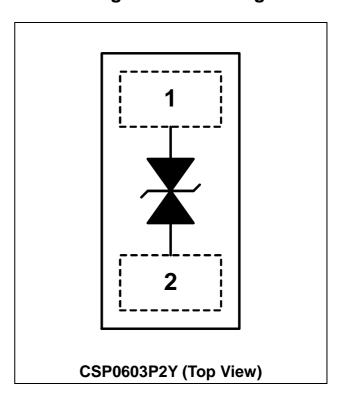
AZ5A85-01B is a design which includes a bi-directional ESD rated clamping cell to protect one power line, or one control line, or one low speed data line in an electronic systems. The AZ5A85-01B has been specifically designed to protect sensitive components which are

connected to power and control lines from over-voltage damage and latch-up caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

AZ5A85-01B is a unique design which includes proprietary clamping cell in a single package. During transient conditions, the proprietary clamping cell prevents over-voltage on the power line or control/data lines, protecting any downstream components.

AZ5A85-01B may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge).

Circuit Diagram / Pin Configuration



SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS			
PARAMETER	SYMBOL	RATING	UNITS
Peak Pulse Current (tp =8/20μs)	I_{PP}	16	А
Operating Supply Voltage (pin-1 to pin-2)	V_{DC}	±5.5	V
Pin-1 to pin-2 ESD per IEC 61000-4-2 (Air)	V _{ESD-1}	±25	kV
Pin-1 to pin-2 ESD per IEC 61000-4-2 (Contact)	V_{ESD-2}	±25	
Lead Soldering Temperature	T _{SOL}	260 (10 sec.)	°C
Operating Temperature	T _{OP}	-55 to +85	°C
Storage Temperature	T _{STO}	-55 to +150	°C

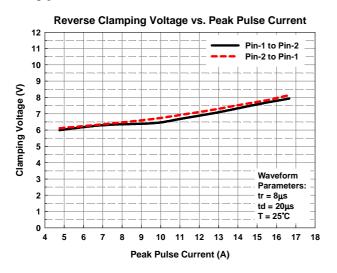
ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNITS
Reverse						
Stand-Off	V_{RWM}	T=25 °C.	-5		5	V
Voltage						
Reverse	ı	V 15V T 25 °C			100	nA
Leakage Current	l _{Leak}	$V_{RWM} = \pm 5V$, T=25 °C.			100	IIA
Reverse						
Breakdown	V_{BV}	I_{BV} = 1mA, T=25 °C.	6		9	V
Voltage						
Surge Clamping	M	L 5A to 9/2000 T 25 °C		6		V
Voltage	$V_{\text{CL-surge}}$	I _{PP} =5A, tp=8/20μs, T=25 °C.		0		V
ESD Clamping	\/	IEC 61000-4-2 +8kV ($I_{TLP} = 16A$),		6		V
Voltage (Note 1)	$V_{\sf clamp}$	Contact mode, T=25 °C		0		
ESD Dynamic		IEC 61000-4-2 0~+8kV, T=25 °C,				
Turn-on	$R_{dynamic}$	Contact mode.		0.03		Ω
Resistance		Contact mode.				
Channel Input		V 0V 6 4MU- T 05 °C		31	45	nE
Capacitance	C _{IN}	$V_R = 0V$, $f = 1MHz$, $T=25$ °C.		31	40	pF

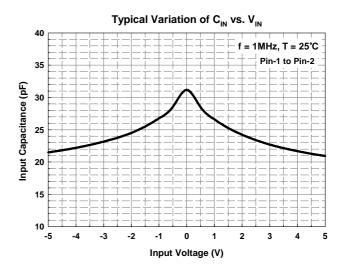
Note 1: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

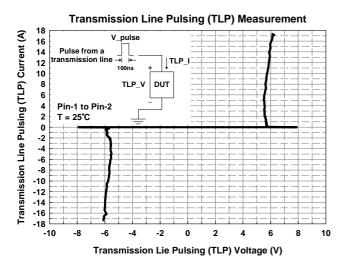
TLP conditions: Z_0 = 50 Ω , t_p = 100ns, t_r = 1ns.



Typical Characteristics









Applications Information

The AZ5A85-01B is designed to protect one line against System ESD/EFT/Lightning pulses by clamping it to an acceptable reference. It provides bi-directional protection.

The usage of the AZ5A85-01B is shown in Fig. 1. Protected line, such as data line, control line, or power line, is connected at pin 1. The pin 2 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ5A85-01B should be kept as short as possible.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ5A85-01B.
- Place the AZ5A85-01B near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to PCB internal circuit.

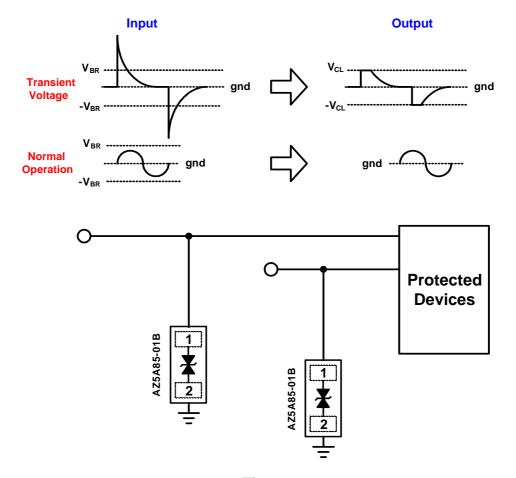


Fig. 1

Fig. 2 shows another simplified example of using AZ5A85-01B to protect the control line, low

speed data line, and power line from ESD transient stress.

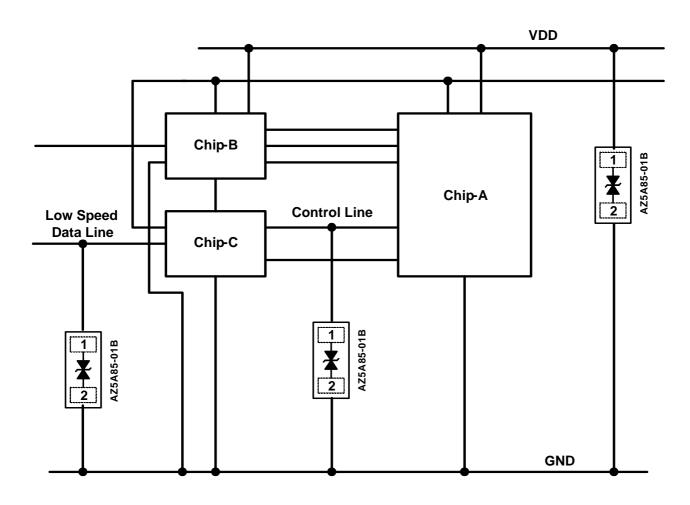
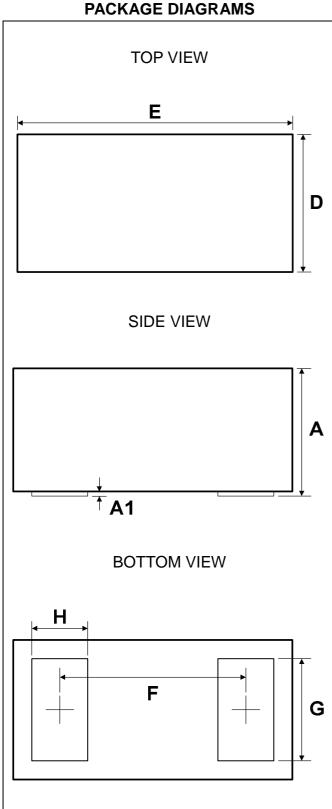


Fig. 2



Mechanical Details CSP0603P2Y PACKAGE DIAGRAM

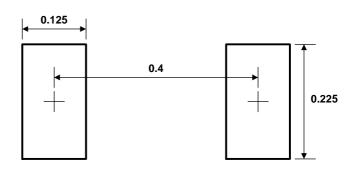


PACKAGE DIMENSIONS

Symbol	Millimeters			
	MIN.	TYP.	MAX.	
D	0.275	0.300	0.325	
E	0.575	0.600	0.625	
Α	0.256	0.276	0.296	
A 1		0.011		
F		0.400		
G	0.210	0.220	0.230	
Н	0.110	0.120	0.130	

LAND LAYOUT

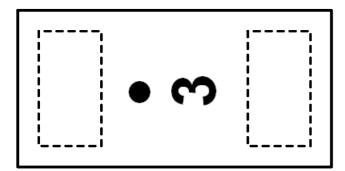
Unit: mm



Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

MARKING CODE



Part Number	Marking Code
AZ5A85-01B	3
(Green Part)	3

Note: Green means Pb-free, RoHS, and Halogen free compliant.

3 = Device Code

Ordering Information

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ5A85-01B.R7G	Green	T/R	7 inch	15,000/reel	4 reel = 60,000/box	6 box = 360,000/carton

Revision History

Revision	Modification Description		
Revision 2015/07/07	Preliminary Release.		
Revision 2015/10/06	Update the maximum spec. of Leakage Current.		
Revision 2016/07/15	Revise Description.		
Revision 2016/11/21	Formal Release.		